

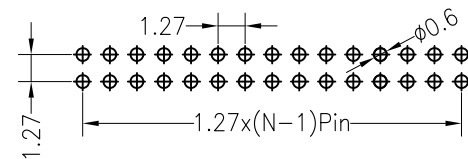
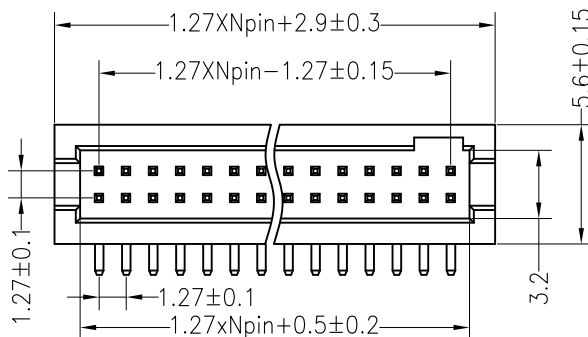


**SPECIFICATIONS**

Rated Current:1.0AMP  
 Contact Resistance:20mΩ Max  
 Withstand Voltage:500V AC/DC  
 Insulation Resistance:1000MΩ Min  
 Operation Temperature:-40°c to +105°c

Contact Material:Brass  
 Contact Plating:Au or Sn Over Ni  
 Insulator Material:Polyester(UL94V-0)  
 Standard: PA6T  
 Max.Processing Temp: 230°C for 30-60 seconds  
 (260°C for 10 seconds)

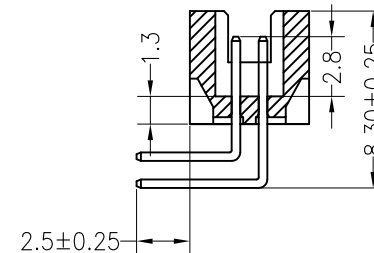
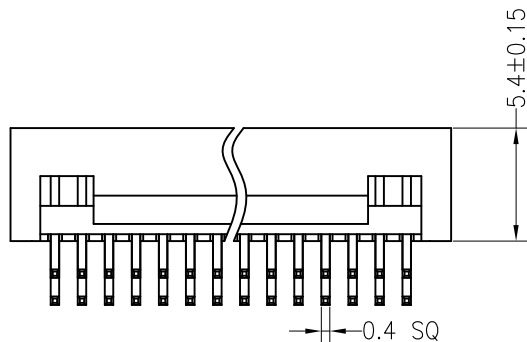
Recommended P.C.B Layout(Top Side)  
 (PCB BOARD TOLERANCE±0.05)



**Ordering Information**

3231 XX R XX X B K00 X 0X

- No.of Pins: 10-100P
- Contact Plating: G0:Gold Flash, G2:5U" Gold, G3:10U" Gold, G4:15U" Gold, G5:30U" Gold, S0:Gold Flash/Tin, SN:Tin
- Insulator Material Option: A=BK-PBT, B=BK-PA66, C=BK-PA6T, D=BK-PA46, E=BK-PA9T, F=BK-LCP
- Packing: 0=PE Bag, A=Tray, T=Tube



OPERATION		DRAW	Liu Miao	12.09.18	SCALE	FIT	<b>WFD</b> 深圳市旺富达电子有限公司 CONN SHEN ZHEN WFD ELECTRONICS CO., LTD	
X.X	±0.30				UNIT	mm		
X.XX	±0.20	CHECK	SIZE	A4	PART NO.	3231-XXRXXB00X01		
X.XXX	±0.10	APPROVE	SHEET	1/1				
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	DIM	TOL	PROJ.	TITLE:	1.27Box Header Npin H5.4 90° L10.0 12.5

A0	2012.09.18	NEW DRAWING	
REV	DATE	MODIFICATION DESCRIPTION	CHANGE